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Details

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Product Status	Active
Core Processor	PIC
Core Size	16-Bit
Speed	32MHz
Connectivity	I ² C, SPI, UART/USART, USB OTG
Peripherals	Brown-out Detect/Reset, LVD, POR, PWM, WDT
Number of I/O	51
Program Memory Size	64KB (22K x 24)
Program Memory Type	FLASH
EEPROM Size	
RAM Size	16K x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 3.6V
Data Converters	A/D 16x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-TQFP
Supplier Device Package	64-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic24fj64gb106-i-pt

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Peripheral Features:

- Peripheral Pin Select (PPS):
 - Allows independent I/O mapping of many peripherals at run time
 - Continuous hardware integrity checking and safety interlocks prevent unintentional configuration changes
 - Up to 44 available pins (100-pin devices)
- Three 3-Wire/4-Wire SPI modules (supports 4 Frame modes) with 8-Level FIFO Buffer
- Three I²C[™] modules support Multi-Master/Slave modes and 7-Bit/10-Bit Addressing
- Four UART modules:
 - Supports RS-485, RS-232, LIN/J2602 protocols and $\text{IrDA}^{\textcircled{R}}$
 - On-chip hardware encoder/decoder for IrDA
 - Auto-wake-up and Auto-Baud Detect (ABD)
 - 4-level deep FIFO buffer
- Five 16-Bit Timers/Counters with Programmable Prescaler
- Nine 16-Bit Capture Inputs, each with a Dedicated Time Base
- Nine 16-Bit Compare/PWM Outputs, each with a Dedicated Time Base
- 8-Bit Parallel Master Port (PMP/PSP):
 - Up to 16 address pins
- Programmable polarity on control lines
- Hardware Real-Time Clock/Calendar (RTCC):
 Provides clock, calendar and alarm functions
- Programmable Cyclic Redundancy Check (CRC) Generator
- Up to 5 External Interrupt Sources

Special Microcontroller Features:

- Operating Voltage Range of 2.0V to 3.6V
- Self-Reprogrammable under Software Control
- 5.5V Tolerant Input (digital pins only)
- Configurable Open-Drain Outputs on Digital I/O
- High-Current Sink/Source (18 mA/18 mA) on all I/O
- Selectable Power Management modes:
- Sleep, Idle and Doze modes with fast wake-upFail-Safe Clock Monitor Operation:
- Detects clock failure and switches to on-chip, Low-Power RC Oscillator
- On-Chip LDO Regulator
- Power-on Reset (POR), Power-up Timer (PWRT), Low-Voltage Detect (LVD) and Oscillator Start-up Timer (OST)
- Flexible Watchdog Timer (WDT) with On-Chip. Low-Power RC Oscillator for Reliable Operation
- In-Circuit Serial Programming[™] (ICSP[™]) and In-Circuit Debug (ICD) via 2 Pins
- · JTAG Boundary Scan and Programming Support
- Brown-out Reset (BOR)
- Flash Program Memory:
 - 10,000 erase/write cycle endurance (minimum)
 - 20-year data retention minimum
 - Selectable write protection boundary
 - Write protection option for Flash Configuration Words



		Pin Number			Input	
Function	64-Pin TQFP, QFN	80-Pin TQFP	100-Pin TQFP	I/O	Input Buffer	Description
AN0	16	20	25	Ι	ANA	A/D Analog Inputs.
AN1	15	19	24	I	ANA	
AN2	14	18	23	I	ANA	
AN3	13	17	22	I	ANA	
AN4	12	16	21	I	ANA	
AN5	11	15	20	I	ANA	
AN6	17	21	26	I	ANA	
AN7	18	22	27	I	ANA	
AN8	21	27	32	I	ANA	
AN9	22	28	33	I	ANA	
AN10	23	29	34	I	ANA	
AN11	24	30	35	I	ANA	
AN12	27	33	41	I	ANA	
AN13	28	34	42	I	ANA	
AN14	29	35	43	I	ANA	
AN15	30	36	44	I	ANA	
AVDD	19	25	30	Р	_	Positive Supply for Analog modules.
AVss	20	26	31	Р	—	Ground Reference for Analog modules.
C1INA	11	15	20	I	ANA	Comparator 1 Input A.
C1INB	12	16	21	I	ANA	Comparator 1 Input B.
C1INC	5	7	11	I	ANA	Comparator 1 Input C.
C1IND	4	6	10	I	ANA	Comparator 1 Input D.
C2INA	13	17	22	I	ANA	Comparator 2 Input A.
C2INB	14	18	23	I	ANA	Comparator 2 Input B.
C2INC	8	10	14	I	ANA	Comparator 2 Input C.
C2IND	6	8	12	I	ANA	Comparator 2 Input D.
C3INA	55	69	84	I	ANA	Comparator 3 Input A.
C3INB	54	68	83	I	ANA	Comparator 3 Input B.
C3INC	48	60	74	I	ANA	Comparator 3 Input C.
C3IND	47	59	73	I	ANA	Comparator 3 Input D.
CLKI	39	49	63	Ι	ANA	Main Clock Input Connection.
CLKO	40	50	64	0	_	System Clock Output.

Legend: TTL = TTL input buffer

ANA = Analog level input/output

ST = Schmitt Trigger input buffer

 $I^2C^{TM} = I^2C/SMBus$ input buffer

TABLE 4-7: INPUT CAPTURE REGISTER MAP 1

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File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
IC1CON1	0140	_	—	ICSIDL	ICTSEL2	ICTSEL1	ICTSEL0			_	ICI1	ICI0	ICOV	ICBNE	ICM2	ICM1	ICM0	0000
IC1CON2	0142	_	—	—	—	_	_	—	IC32	ICTRIG	TRIGSTAT	—	SYNCSEL4	SYNCSEL3	SYNCSEL2	SYNCSEL1	SYNCSEL0	000D
IC1BUF	0144								Input Cap	ture 1 Buffe	er Register							0000
IC1TMR	0146								Timer	Value 1 Re	egister							xxxx
IC2CON1	0148	_	—	ICSIDL	ICTSEL2	ICTSEL1	ICTSEL0	—	—	_	ICI1	ICI0	ICOV	ICBNE	ICM2	ICM1	ICM0	0000
IC2CON2	014A	_	—	—	_	_	_	_	IC32	ICTRIG	TRIGSTAT		SYNCSEL4	SYNCSEL3	SYNCSEL2	SYNCSEL1	SYNCSEL0	000D
IC2BUF	014C								Input Cap	ture 2 Buffe	er Register							0000
IC2TMR	014E		Timer Value 2 Register											xxxx				
IC3CON1	0150	_	—	ICSIDL	ICTSEL2	ICTSEL1	ICTSEL0	—	—	_	ICI1	ICI0	ICOV	ICBNE	ICM2	ICM1	ICM0	0000
IC3CON2	0152	_	_	—	_	_	_	_	IC32	ICTRIG	TRIGSTAT	_	SYNCSEL4	SYNCSEL3	SYNCSEL2	SYNCSEL1	SYNCSEL0	000D
IC3BUF	0154								Input Cap	ture 3 Buffe	er Register							0000
IC3TMR	0156								Timer	Value 3 R	egister							xxxx
IC4CON1	0158	_	_	ICSIDL	ICTSEL2	ICTSEL1	ICTSEL0	_	_	_	ICI1	ICI0	ICOV	ICBNE	ICM2	ICM1	ICM0	0000
IC4CON2	015A	_	—	—	—	_	_	—	IC32	ICTRIG	TRIGSTAT	—	SYNCSEL4	SYNCSEL3	SYNCSEL2	SYNCSEL1	SYNCSEL0	000D
IC4BUF	015C								Input Cap	ture 4 Buffe	er Register							0000
IC4TMR	015E		Timer Value 4 Register										xxxx					
IC5CON1	0160	_	—	ICSIDL	ICTSEL2	ICTSEL1	ICTSEL0	—	—	_	ICI1	ICI0	ICOV	ICBNE	ICM2	ICM1	ICM0	0000
IC5CON2	0162	_	—	—	_	_	_	—	IC32	ICTRIG	TRIGSTAT	—	SYNCSEL4	SYNCSEL3	SYNCSEL2	SYNCSEL1	SYNCSEL0	000D
IC5BUF	0164								Input Cap	ture 5 Buffe	er Register							0000
IC5TMR	0166								Timer	Value 5 R	egister							xxxx
IC6CON1	0168	_	—	ICSIDL	ICTSEL2	ICTSEL1	ICTSEL0	—	—	_	ICI1	ICI0	ICOV	ICBNE	ICM2	ICM1	ICM0	0000
IC6CON2	016A	_	_	—	_	_	_	_	IC32	ICTRIG	TRIGSTAT	_	SYNCSEL4	SYNCSEL3	SYNCSEL2	SYNCSEL1	SYNCSEL0	000D
IC6BUF	016C								Input Cap	ture 6 Buffe	er Register							0000
IC6TMR	016E								Timer	Value 6 Re	egister							xxxx
IC7CON1	0170	_	—	ICSIDL	ICTSEL2	ICTSEL1	ICTSEL0	—	—	_	ICI1	ICI0	ICOV	ICBNE	ICM2	ICM1	ICM0	0000
IC7CON2	0172	_	—	—	—	_	_	—	IC32	ICTRIG	TRIGSTAT		SYNCSEL4	SYNCSEL3	SYNCSEL2	SYNCSEL1	SYNCSEL0	000D
IC7BUF	0174								Input Cap	ture 7 Buffe	er Register							0000
IC7TMR	0176								Timer	Value 7 R	egister							xxxx
IC8CON1	0178	_	—	ICSIDL	ICTSEL2	ICTSEL1	ICTSEL0	—	—	_	ICI1	ICI0	ICOV	ICBNE	ICM2	ICM1	ICM0	0000
IC8CON2	017A	_	_	_	_	_	_	—	IC32	ICTRIG	TRIGSTAT	—	SYNCSEL4	SYNCSEL3	SYNCSEL2	SYNCSEL1	SYNCSEL0	000D
IC8BUF	017C								Input Cap	ture 8 Buffe	er Register							0000
IC8TMR	017E		Timer Value 8 Register									xxxx						
IC9CON1	0180	ICSIDL ICTSEL2 ICTSEL1 ICTSEL0 ICI1 ICI0 ICOV ICBNE ICM2 ICM1 ICM0 000									0000							
IC9CON2	0182	IC32 ICTRIG TRIGSTAT - SYNCSEL4 SYNCSEL3 SYNCSEL2 SYNCSEL1 SYNCSEL0 000D																
IC9BUF	0184	184 Input Capture 9 Buffer Register 00									0000							
IC9TMR	0186	0186 Timer Value 9 Register xxx									xxxx							
Legend:	— = ı	— = unimplemented, read as '0'. Reset values are shown in hexadecimal.																

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TABLE 4-8: OUTPUT COMPARE REGISTER MAP

					1									1		1		· · ·
File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
OC1CON1	0190	—	—	OCSIDL	OCTSEL2	OCTSEL1	OCTSEL0	—	—	ENFLT0	—	—	OCFLT0	TRIGMODE	OCM2	OCM1	OCM0	0000
OC1CON2	0192	FLTMD	FLTOUT	FLTTRIEN	OCINV	_	_		OC32	OCTRIG	TRIGSTAT	OCTRIS	SYNCSEL4	SYNCSEL3	SYNCSEL2	SYNCSEL1	SYNCSEL0) 000C
OC1RS	0194							C	utput Compa	are 1 Secon	dary Register							0000
OC1R	0196								Output 0	Compare 1 F	legister							0000
OC1TMR	0198								Timer	Value 1 Reg	jister							xxxx
OC2CON1	019A	—	—	OCSIDL	OCTSEL2	OCTSEL1	OCTSEL0	_	—	ENFLT0		—	OCFLT0	TRIGMODE	OCM2	OCM1	OCM0	0000
OC2CON2	019C	FLTMD	FLTOUT	FLTTRIEN	OCINV	_	—	_	OC32	OCTRIG	TRIGSTAT	OCTRIS	SYNCSEL4	SYNCSEL3	SYNCSEL2	SYNCSEL1	SYNCSEL0	000C
OC2RS	019E		Output Compare 2 Secondary Register										0000					
OC2R	01A0		Output Compare 2 Register 00											0000				
OC2TMR	01A2								Timer	Value 2 Reg	jister							xxxx
OC3CON1	01A4	—	—	OCSIDL	OCTSEL2	OCTSEL1	OCTSEL0	—	—	ENFLT0	—	—	OCFLT0	TRIGMODE	OCM2	OCM1	OCM0	0000
OC3CON2	01A6	FLTMD	FLTOUT	FLTTRIEN	OCINV	_	—	_	OC32	OCTRIG	TRIGSTAT	OCTRIS	SYNCSEL4	SYNCSEL3	SYNCSEL2	SYNCSEL1	SYNCSEL0	000C
OC3RS	01A8							С	utput Compa	are 3 Secon	dary Register							0000
OC3R	01AA	Output Compare 3 Register 00											0000					
OC3TMR	01AC								Timer	Value 3 Reg	jister							xxxx
OC4CON1	01AE	—	—	OCSIDL	OCTSEL2	OCTSEL1	OCTSEL0	_	—	ENFLT0		—	OCFLT0	TRIGMODE	OCM2	OCM1	OCM0	0000
OC4CON2	01B0	FLTMD	FLTOUT	FLTTRIEN	OCINV	—	—	—	OC32	OCTRIG	TRIGSTAT	OCTRIS	SYNCSEL4	SYNCSEL3	SYNCSEL2	SYNCSEL1	SYNCSEL0	000C
OC4RS	01B2							С	utput Compa	are 4 Secon	dary Register							0000
OC4R	01B4								Output C	Compare 4 F	Register							0000
OC4TMR	01B6								Timer	Value 4 Reg	jister							xxxx
OC5CON1	01B8	—	—	OCSIDL	OCTSEL2	OCTSEL1	OCTSEL0	_	—	ENFLT0	—	—	OCFLT0	TRIGMODE	OCM2	OCM1	OCM0	0000
OC5CON2	01BA	FLTMD	FLTOUT	FLTTRIEN	OCINV	_	—	_	OC32	OCTRIG	TRIGSTAT	OCTRIS	SYNCSEL4	SYNCSEL3	SYNCSEL2	SYNCSEL1	SYNCSEL0	000C
OC5RS	01BC							C	utput Compa	are 5 Secon	dary Register							0000
OC5R	01BE								Output 0	Compare 5 F	Register							0000
OC5TMR	01C0								Timer	Value 5 Reg	jister							xxxx
OC6CON1	01C2	—	—	OCSIDL	OCTSEL2	OCTSEL1	OCTSEL0	_	—	ENFLT0		—	OCFLT0	TRIGMODE	OCM2	OCM1	OCM0	0000
OC6CON2	01C4	FLTMD	FLTOUT	FLTTRIEN	OCINV	_	—	_	OC32	OCTRIG	TRIGSTAT	OCTRIS	SYNCSEL4	SYNCSEL3	SYNCSEL2	SYNCSEL1	SYNCSEL0	000C
OC6RS	01C6							C	utput Compa	are 6 Secon	dary Register							0000
OC6R	01C8	Output Compare 6 Register 00									0000							
OC6TMR	01CA	Timer Value 6 Register									xxxx							
OC7CON1	01CC	OCSIDL OCTSEL2 OCTSEL1 OCTSEL0 ENFLTO - OCFLTO TRIGMODE OCM2 OCM1 OCM0									0000							
OC7CON2	01CE	FLTMD	FLTOUT	FLTTRIEN	OCINV	—	_	—	OC32	OCTRIG	TRIGSTAT	OCTRIS	SYNCSEL4	SYNCSEL3	SYNCSEL2	SYNCSEL1	SYNCSELO) 000C
OC7RS	01D0	00 Output Compare 7 Secondary Register									0000							
OC7R	01D2	000 Output Compare 7 Register									0000							
OC7TMR	01D4			Timer Value 7 Register xxxx									xxxx					

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 4-8: OUTPUT COMPARE REGISTER MAP (CONTINUED)

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
OC8CON1	01D6	_	—	OCSIDL	OCTSEL2	OCTSEL1	OCTSEL0	_	_	ENFLT0	—	—	OCFLT0	TRIGMODE	OCM2	OCM1	OCM0	0000
OC8CON2	01D8	FLTMD	FLTOUT	FLTTRIEN	OCINV		—	—	OC32	OCTRIG	TRIGSTAT	OCTRIS	SYNCSEL4	SYNCSEL3	SYNCSEL2	SYNCSEL1	SYNCSEL0	000C
OC8RS	01DA							0	utput Compa	are 8 Second	lary Register							0000
OC8R	01DC		Output Compare 8 Register 0000															
OC8TMR	01DE								Timer	Value 8 Reg	ister							xxxx
OC9CON1	01E0		_	OCSIDL	OCTSEL2	OCTSEL1	OCTSEL0	_	_	ENFLT0			OCFLT0	TRIGMODE	OCM2	OCM1	OCM0	0000
OC9CON2	01E2	FLTMD	FLTOUT	FLTTRIEN	OCINV	-	—	—	OC32	OCTRIG	TRIGSTAT	OCTRIS	SYNCSEL4	SYNCSEL3	SYNCSEL2	SYNCSEL1	SYNCSEL0	000C
OC9RS	01E4		Output Compare 9 Secondary Register 0000							0000								
OC9R	01E6		Output Compare 9 Register 0000								0000							
OC9TMR	01E8		Timer Value 9 Register xxxx															

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 4-9: I²C[™] REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
I2C1RCV	0200	_	_	—	_	—	_	—	Receive Register							0000		
I2C1TRN	0202	_	_	_	_	_	_	_	_				Transmit	Register				OOFF
I2C1BRG	0204	_	_	—	_	—	—	_				Baud Rat	e Generato	r Register				0000
I2C1CON	0206	I2CEN	_	I2CSIDL	SCLREL	IPMIEN	A10M	DISSLW	SMEN	GCEN	STREN	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	1000
I2C1STAT	0208	ACKSTAT	TRSTAT	_	_	_	BCL	GCSTAT	ADD10	IWCOL	I2COV	D/A	Р	S	R/W	RBF	TBF	0000
I2C1ADD	020A	_	_	—	_	-	_					Address	Register					0000
I2C1MSK	020C	_	_	—	_	—	—					Address Ma	ask Registe	r				0000
I2C2RCV	0210	_	_	_	_	_	_	_	_				Receive	Register				0000
I2C2TRN	0212	—	_	—	_	—	—	—	—				Transmit	Register				00FF
I2C2BRG	0214		_	—	_	—	—	—				Baud Rat	e Generato	r Register				0000
I2C2CON	0216	I2CEN	_	I2CSIDL	SCLREL	IPMIEN	A10M	DISSLW	SMEN	GCEN	STREN	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	1000
I2C2STAT	0218	ACKSTAT	TRSTAT	—	_	_	BCL	GCSTAT	ADD10	IWCOL	I2COV	D/A	Р	S	R/W	RBF	TBF	0000
I2C2ADD	021A	_	_	—	_	-	_					Address	Register					0000
I2C2MSK	021C	_	_	—	_	—	—					Address Ma	ask Registe	r				0000
I2C3RCV	0270	_	_	_	_	_	_	_	_				Receive	Register				0000
I2C3TRN	0272	_	—	_	—	_	—	—	—				Transmit	Register				00FF
I2C3BRG	0274	_	_	—	_	—	—	_	Baud Rate Generator Register 0						0000			
I2C3CON	0276	I2CEN	_	I2CSIDL	SCLREL	IPMIEN	A10M	DISSLW	SLW SMEN GCEN STREN ACKDT ACKEN RCEN PEN RSEN SEN :						1000			
I2C3STAT	0278	ACKSTAT	TRSTAT	_	_	_	BCL	GCSTAT	CSTAT ADD10 IWCOL I2COV D/A P S R/W RBF TBF or						0000			
I2C3ADD	027A	_	—	—	_	—	—	Address Register 00						0000				
I2C3MSK	027C	_		—		—	_	Address Mask Register 0							0000			

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

8.0 OSCILLATOR CONFIGURATION

Note:	This data sheet summarizes the features
	of this group of PIC24F devices. It is not
	intended to be a comprehensive reference
	source. For more information, refer to the
	"PIC24F Family Reference Manual",
	Section 6. "Oscillator" (DS39700).

The oscillator system for PIC24FJ256GB110 family devices has the following features:

• A total of four external and internal oscillator options as clock sources, providing 11 different clock modes

- An on-chip USB PLL block to provide a stable, 48 MHz clock for the USB module as well as a range of frequency options for the system clock
- Software-controllable switching between various clock sources
- Software-controllable postscaler for selective clocking of CPU for system power savings
- A Fail-Safe Clock Monitor (FSCM) that detects clock failure and permits safe application recovery or shutdown
- A separate and independently configurable system clock output for synchronizing external hardware

A simplified diagram of the oscillator system is shown in Figure 8-1.



FIGURE 8-1: PIC24FJ256GB110 FAMILY CLOCK DIAGRAM

9.2.2 IDLE MODE

Idle mode has these features:

- The CPU will stop executing instructions.
- The WDT is automatically cleared.
- The system clock source remains active. By default, all peripheral modules continue to operate normally from the system clock source, but can also be selectively disabled (see Section 9.4 "Selective Peripheral Module Control").
- If the WDT or FSCM is enabled, the LPRC will also remain active.

The device will wake from Idle mode on any of these events:

- Any interrupt that is individually enabled.
- · Any device Reset.
- A WDT time-out.

On wake-up from Idle, the clock is reapplied to the CPU and instruction execution begins immediately, starting with the instruction following the PWRSAV instruction or the first instruction in the ISR.

9.2.3 INTERRUPTS COINCIDENT WITH POWER SAVE INSTRUCTIONS

Any interrupt that coincides with the execution of a PWRSAV instruction will be held off until entry into Sleep or Idle mode has completed. The device will then wake-up from Sleep or Idle mode.

9.3 Doze Mode

Generally, changing clock speed and invoking one of the power-saving modes are the preferred strategies for reducing power consumption. There may be circumstances, however, where this is not practical. For example, it may be necessary for an application to maintain uninterrupted synchronous communication, even while it is doing nothing else. Reducing system clock speed may introduce communication errors, while using a power-saving mode may stop communications completely.

Doze mode is a simple and effective alternative method to reduce power consumption while the device is still executing code. In this mode, the system clock continues to operate from the same source and at the same speed. Peripheral modules continue to be clocked at the same speed while the CPU clock speed is reduced. Synchronization between the two clock domains is maintained, allowing the peripherals to access the SFRs while the CPU executes code at a slower rate.

Doze mode is enabled by setting the DOZEN bit (CLKDIV<11>). The ratio between peripheral and core clock speed is determined by the DOZE<2:0> bits (CLKDIV<14:12>). There are eight possible configurations, from 1:1 to 1:256, with 1:1 being the default.

It is also possible to use Doze mode to selectively reduce power consumption in event driven applications. This allows clock-sensitive functions, such as synchronous communications, to continue without interruption while the CPU Idles, waiting for something to invoke an interrupt routine. Enabling the automatic return to full-speed CPU operation on interrupts is enabled by setting the ROI bit (CLKDIV<15>). By default, interrupt events have no effect on Doze mode operation.

9.4 Selective Peripheral Module Control

Idle and Doze modes allow users to substantially reduce power consumption by slowing or stopping the CPU clock. Even so, peripheral modules still remain clocked, and thus, consume power. There may be cases where the application needs what these modes do not provide: the allocation of power resources to CPU processing with minimal power consumption from the peripherals.

PIC24F devices address this requirement by allowing peripheral modules to be selectively disabled, reducing or eliminating their power consumption. This can be done with two control bits:

- The Peripheral Enable bit, generically named, "XXXEN", located in the module's main control SFR.
- The Peripheral Module Disable (PMD) bit, generically named, "XXXMD", located in one of the PMD Control registers.

Both bits have similar functions in enabling or disabling their associated module. Setting the PMD bit for a module disables all clock sources to that module, reducing its power consumption to an absolute minimum. In this state, the control and status registers associated with the peripheral will also be disabled, so writes to those registers will have no effect and read values will be invalid. Many peripheral modules have a corresponding PMD bit.

In contrast, disabling a module by clearing its XXXEN bit disables its functionality, but leaves its registers available to be read and written to. This reduces power consumption, but not by as much as setting the PMD bit does. Most peripheral modules have an enable bit; exceptions include input capture, output compare and RTCC.

To achieve more selective power savings, peripheral modules can also be selectively disabled when the device enters Idle mode. This is done through the control bit of the generic name format, "XXXIDL". By default, all modules that can operate during Idle mode will do so. Using the disable on Idle feature allows further reduction of power consumption during Idle mode, enhancing power savings for extremely critical power applications.

REGISTER 10-5: RPINR4: PERIPHERAL PIN SELECT INPUT REGISTER 4

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
_	—	T5CKR5	T5CKR4	T5CKR3	T5CKR2	T5CKR1	T5CKR0
bit 15							bit 8

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	T4CKR5	T4CKR4	T4CKR3	T4CKR2	T4CKR1	T4CKR0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14	Unimplemented: Read as '0'
bit 13-8	T5CKR<5:0>: Assign Timer5 External Clock (T5CK) to Corresponding RPn or RPIn Pin bits
bit 7-6	Unimplemented: Read as '0'
bit 5-0	T4CKR<5:0>: Assign Timer4 External Clock (T4CK) to Corresponding RPn or RPIn Pin bits

REGISTER 10-6: RPINR7: PERIPHERAL PIN SELECT INPUT REGISTER 7

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	IC2R5	IC2R4	IC2R3	IC2R2	IC2R1	IC2R0
bit 15							bit 8

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	IC1R5	IC1R4	IC1R3	IC1R2	IC1R1	IC1R0
bit 7							bit 0

Legend:				
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 15-14 Unimplemented: Read as '0'

bit 13-8 IC2R<5:0>: Assign Input Capture 2 (IC2) to Corresponding RPn or RPIn Pin bits

bit 7-6 Unimplemented: Read as '0'

bit 5-0 IC1R<5:0>: Assign Input Capture 1 (IC1) to Corresponding RPn or RPIn Pin bits

REGISTER 10-11: RPINR15: PERIPHERAL PIN SELECT INPUT REGISTER 15

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	IC9R5	IC9R4	IC9R3	IC9R2	IC9R1	IC9R0
bit 15							bit 8
U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_		—	—	—			—
bit 7							bit 0
Legend:							
R = Readable bit W = Writable bit			oit	U = Unimplemented bit, read as '0'			
-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is		x = Bit is unkn	iown				

bit 15-14 Unimplemented: Read as '0'

bit 13-8 IC9R<5:0>: Assign Input Capture 9 (IC9) to Corresponding RPn or RPIn Pin bits

bit 7-0 Unimplemented: Read as '0'

REGISTER 10-12: RPINR17: PERIPHERAL PIN SELECT INPUT REGISTER 17

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	U3RXR5	U3RXR4	U3RXR3	U3RXR2	U3RXR1	U3RXR0
bit 15							bit 8
U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 7							bit 0
Legend:							
R = Readable bit W = Writable bit		oit	U = Unimplemented bit, read as '0'				
-n = Value at POR '1' = Bit is set			'0' = Bit is cleared x = Bit is unknown			iown	

bit 15-14 Unimplemented: Read as '0'

bit 13-8 U3RXR<5:0>: Assign UART3 Receive (U3RX) to Corresponding RPn or RPIn Pin bits

bit 7-0 Unimplemented: Read as '0'

REGISTER 10-29:	RPOR7: PERIPHERAL PIN SELECT OUTPUT REGISTER 7
-----------------	---

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	—	RP15R5 ⁽¹⁾	RP15R4 ⁽¹⁾	RP15R3 ⁽¹⁾	RP15R2 ⁽¹⁾	RP15R1 ⁽¹⁾	RP15R0 ⁽¹⁾
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP14R5	RP14R4	RP14R3	RP14R2	RP14R1	RP14R0
bit 7							bit 0

Legend:					
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 15-14	Unimplemented: Read as '0'
bit 13-8	RP15R<5:0>: RP15 Output Pin Mapping bits ⁽¹⁾
	Peripheral output number n is assigned to pin, RP0 (see Table 10-3 for peripheral function numbers)
bit 7-6	Unimplemented: Read as '0'
bit 5-0	RP14R<5:0>: RP14 Output Pin Mapping bits
	Peripheral output number n is assigned to pin, RP14 (see Table 10-3 for peripheral function numbers)

Note 1: Unimplemented on 64-pin devices; read as '0'.

REGISTER 10-30: RPOR8: PERIPHERAL PIN SELECT OUTPUT REGISTER 8

bit 15							bit 8
	<u> </u>	RP17R5	RP17R4	RP17R3	RP17R2	RP17R1	RP17R0
U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0

0-0	0-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP16R5	RP16R4	RP16R3	RP16R2	RP16R1	RP16R0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

 bit 15-14
 Unimplemented: Read as '0'

 bit 13-8
 RP17R<5:0>: RP17 Output Pin Mapping bits Peripheral output number n is assigned to pin, RP17 (see Table 10-3 for peripheral function numbers)

 bit 7-6
 Unimplemented: Read as '0'

 bit 5-0
 RP16R<5:0>: RP16 Output Pin Mapping bits Peripheral output number n is assigned to pin, RP16 (see Table 10-3 for peripheral function numbers)

EQUATION 14-2: CALCULATION FOR MAXIMUM PWM RESOLUTION⁽¹⁾

Maximum PWM Resolution (bits) = $\frac{\log_{10} \left(\frac{FCY}{FPWM \bullet (Timer Prescale Value)} \right)}{\log_{10} \left(\frac{FCY}{FPWM \bullet (Timer Prescale Value)} \right)}$

 $\log_{10}(2)$

Note 1: Based on FCY = FOSC/2, Doze mode and PLL are disabled.

EXAMPLE 14-1: PWM PERIOD AND DUTY CYCLE CALCULATIONS⁽¹⁾

Find the Timer Period register value for a desired PWM frequency of 52.08 kHz, where FOSC = 8 MHz with PLL (32 MHz device clock rate) and a Timer2 prescaler setting of 1:1.
 TCY = 2 * TOSC = 62.5 ns
 PWM Period = 1/PWM Frequency = 1/52.08 kHz = 19.2 µs
 PWM Period = (PR2 + 1) • TCY • (Timer 2 Prescale Value)
 19.2 µs = (PR2 + 1) • 62.5 ns • 1
 PR2 = 306

 Find the maximum resolution of the duty cycle that can be used with a 52.08 kHz frequency and a 32 MHz device clock rate:
 PWM Resolution = log₁₀(FCY/FPWM)/log₁₀2) bits
 = (log₁₀(16 MHz/52.08 kHz)/log₁₀2) bits
 = 8.3 bits

Note 1: Based on TCY = 2 * Tosc; Doze mode and PLL are disabled.

TABLE 14-1: EXAMPLE PWM FREQUENCIES AND RESOLUTIONS AT 4 MIPS (Fcy = 4 MHz)⁽¹⁾

PWM Frequency	7.6 Hz	61 Hz	122 Hz	977 Hz	3.9 kHz	31.3 kHz	125 kHz
Timer Prescaler Ratio	8	1	1	1	1	1	1
Period Register Value	FFFFh	FFFFh	7FFFh	0FFFh	03FFh	007Fh	001Fh
Resolution (bits)	16	16	15	12	10	7	5

Note 1: Based on FCY = FOSC/2, Doze mode and PLL are disabled.

TABLE 14-2: EXAMPLE PWM FREQUENCIES AND RESOLUTIONS AT 16 MIPS (Fcy = 16 MHz)⁽¹⁾

PWM Frequency	30.5 Hz	244 Hz	488 Hz	3.9 kHz	15.6 kHz	125 kHz	500 kHz
Timer Prescaler Ratio	8	1	1	1	1	1	1
Period Register Value	FFFFh	FFFFh	7FFFh	0FFFh	03FFh	007Fh	001Fh
Resolution (bits)	16	16	15	12	10	7	5

Note 1: Based on FCY = FOSC/2, Doze mode and PLL are disabled.

18.7.1 USB OTG MODULE CONTROL REGISTERS

REGISTER 18-3: U1OTGSTAT: USB OTG STATUS REGISTER (HOST MODE ONLY)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
	—	—		—	—	_	—	
bit 15							bit 8	
R-0, HSC	U-0	R-0, HSC	U-0	R-0, HSC	R-0, HSC	U-0	R-0, HSC	
ID	—	LSTATE	—	SESVD	SESEND	—	VBUSVD	
bit 7							bit 0	
Legend:				U = Unimplen	nented bit, read	l as '0'		
R = Readable	e bit	W = Writable I	pit	HSC = Hardw	are Settable/C	learable bit		
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unk	nown	
bit 15-8	Unimplemen	ted: Read as '0)'					
bit 7	ID: ID Pin Sta	te Indicator bit						
	1 = No plug i	s attached, or a	type B cable	has been plugg	jed into the US	B receptacle		
	0 = A type A	plug nas been	piuggea into ti	ne USB recepta	icie			
bit 6	Unimplemen	ted: Read as '0)´ 					
bit 5		e State Stable In	Idicator bit					
	1 = The USB 0 = The USB	line state (as o line state has l	NOT been sta	ble for the previ	nas been stabl	e for the previo	bus 1 ms	
bit 4		ted: Read as '('					
bit 3	SESVD: Sess	sion Valid Indica	ntor bit					
bit o	1 = The VBU	s voltage is abo	ove VA SESS	VLD (as defined	in the USB O	TG Specificatio	on) on the A or	
	B-device	0		Υ.			,	
	0 = The VBUS	s voltage is belo	w VA_SESS_V	LD on the A or I	3-device			
bit 2	SESEND: B-S	Session End Ind	licator bit					
	1 = The VBU B-device	s voltage is be	elow VB_SESS	END (as defin	ed in the USE	3 OTG Specifi	ication) on the	
	0 = The VBUS	s voltage is abo	ve VB_SESS_E	END on the B-de	vice			
bit 1	Unimplemen	ted: Read as '0)'					
bit 0	VBUSVD: A-V	VBUS Valid Indic	ator bit					
	1 = The VBU A-device	s voltage is at	ove VA_vBUS	S_VLD (as defin	ed in the USE	3 OTG Specifi	ication) on the	
	0 = The VBUS voltage is below VA_VBUS_VLD on the A-device							

REGISTER 18-16: U1IR: USB INTERRUPT STATUS REGISTER (DEVICE MODE ONLY)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

R/K-0, HS	U-0	R/K-0, HS	R/K-0, HS	R/K-0, HS	R/K-0, HS	R-0	R/K-0, HS
STALLIF	—	RESUMEIF	IDLEIF	TRNIF	SOFIF	UERRIF	URSTIF
bit 7				•	•		bit 0

Legend:	U = Unimplemented bit, read as '0'					
R = Readable bit	K = Write '1' to clear bit	HS = Hardware Settable bit				
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown			

bit 15-8	Unimplemented: Read as '0'
bit 7	STALLIF: STALL Handshake Interrupt bit
	 1 = A STALL handshake was sent by the peripheral during the handshake phase of the transaction in Device mode
	0 = A STALL handshake has not been sent
bit 6	Unimplemented: Read as '0'
bit 5	RESUMEIF: Resume Interrupt bit
	 1 = A K-state is observed on the D+ or D- pin for 2.5 μs (differential '1' for low speed, differential '0' for full speed) 0 = No K state observed
hi+ 1	0 - NO K-side Observed
DIL 4	 1 = Idle condition detected (constant Idle state of 3 ms or more) 0 = No Idle condition detected
bit 3	TRNIF: Token Processing Complete Interrupt bit
	 1 = Processing of current token is complete; read U1STAT register for endpoint information 0 = Processing of current token not complete; clear U1STAT register or load next token from STAT (clearing this bit causes the STAT FIFO to advance)
bit 2	SOFIF: Start-Of-Frame Token Interrupt bit
	1 = A Start-Of-Frame token received by the peripheral or the Start-Of-Frame threshold reached by the host
	0 = No Start-Of-Frame token received or threshold reached
bit 1	UERRIF : USB Error Condition Interrupt bit (read-only)
	 1 = An unmasked error condition has occurred; only error states enabled in the U1EIE register can set this bit
	0 = No unmasked error condition has occurred
bit 0	URSTIF: USB Reset Interrupt bit
	 1 = Valid USB Reset has occurred for at least 2.5 μs; Reset state must be cleared before this bit can be reasserted
	0 = No USB Reset has occurred. Individual bits can only be cleared by writing a '1' to the bit position as part of a word write operation on the entire register. Using Boolean instructions or bitwise oper- ations to write to a single bit position will cause all set bits at the moment of the write to become cleared.
Note:	Individual bits can only be cleared by writing a '1' to the bit position as part of a word write operation on the entire register. Using Boolean instructions or bitwise operations to write to a single bit position will cause all set bits at the moment of the write to become cleared.

NOTES:

29.1 DC Characteristics

FIGURE 29-1: PIC24FJ256GB110 FAMILY VOLTAGE-FREQUENCY GRAPH (INDUSTRIAL)



TABLE 29-1: THERMAL OPERATING CONDITIONS

Rating	Symbol	Min	Тур	Мах	Unit
PIC24FJ256GB110 Family:					
Operating Junction Temperature Range	TJ	-40		+125	°C
Operating Ambient Temperature Range	TA	-40		+85	°C
Power Dissipation: Internal Chip Power Dissipation: $PINT = VDD x (IDD - \Sigma IOH)$ I/O Pin Power Dissipation: $PI/O = \Sigma (\{VDD - VOH\} x IOH) + \Sigma (VOL x IOL)$	PD		PINT + PI/C)	W
Maximum Allowed Power Dissipation	Pdmax	(TJ – TA)/θJA			W

TABLE 29-2: THERMAL PACKAGING CHARACTERISTICS

Characteristic	Symbol	Тур	Мах	Unit	Notes
Package Thermal Resistance, 14x14x1 mm TQFP	θJA	50.0		°C/W	(Note 1)
Package Thermal Resistance, 12x12x1 mm TQFP	θJA	69.4	-	°C/W	(Note 1)
Package Thermal Resistance, 10x10x1 mm TQFP	θJA	76.6	_	°C/W	(Note 1)
Package Thermal Resistance, 9x9x0.9 mm QFN	θJA	28.0	_	°C/W	(Note 1)

Note 1: Junction to ambient thermal resistance, Theta-JA (θ JA) numbers are achieved by package simulations.

TABLE 29-6: DC CHARACTERISTICS: POWER-DOWN CURRENT (IPD)

DC CHARACTERISTICS			Standard O Operating te	perating Cor	nditions: 2.0\ -40°C ≤ TA ≤	/ to 3.6V (unless otherwise stated) +85°C for Industrial		
Parameter No.	Typical ⁽¹⁾	Мах	Units	Conditions				
Power-Down	Current (IPD) ⁽	2)						
DC60	0.1	1	μA	-40°C				
DC60a	0.15	1	μA	+25°C	2 01/(3)			
DC60m	2.25	11	μA	+60°C	2.00			
DC60b	3.7	18	μA	+85°C				
DC60c	0.2	1.4	μA	-40°C				
DC60d	0.25	1.4	μA	+25°C	2 51/(3)	Race Rower Down Current(5)		
DC60n	2.6	16.5	μA	+60°C	2.30(*)	Base Power-Down Current		
DC60e	4.2	27	μA	+85°C				
DC60f	3.6	10	μA	-40°C				
DC60g	4.0	10	μA	+25°C	2 2\/(4)			
DC60p	8.1	25.2	μA	+60°C	3.3017			
DC60h	11.0	36	μA	+85°C				
DC61	1.75	3	μA	-40°C				
DC61a	1.75	3	μA	+25°C	2 ov (3)			
DC61m	1.75	3	μA	+60°C	2.00			
DC61b	1.75	3	μA	+85°C				
DC61c	2.4	4	μA	-40°C				
DC61d	2.4	4	μA	+25°C	o ∈v(3)	Motobdog Timor Current: Alwor(5)		
DC61n	2.4	4	μA	+60°C	2.30(*)			
DC61e	2.4	4	μA	+85°C				
DC61f	2.8	5	μA	-40°C				
DC61g	2.8	5	μA	+25°C	2 2) (4)			
DC61p	2.8	5	μA	+60°C	3.30			
DC61b	2.8	5	μA	+85°C				

Note 1: Data in the Typical column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

2: Base IPD is measured with all peripherals and clocks shut down. All I/Os are configured as inputs and pulled high. WDT, etc., are all switched off, PMSLP bit is clear, and the Peripheral Module Disable (PMD) bits for all unused peripherals are set.

3: On-chip voltage regulator disabled (ENVREG tied to Vss).

4: On-chip voltage regulator enabled (ENVREG tied to VDD). Low-Voltage Detect (LVD) and Brown-out Detect (BOD) are enabled.

5: The Δ current is the additional current consumed when the module is enabled. This current should be added to the base IPD current.

80-Lead Plastic Thin Quad Flatpack (PT) – 12x12x1 mm Body, 2.00 mm [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimensio	on Limits	MIN	NOM	MAX
Number of Leads	Ν	80		
Lead Pitch	е	0.50 BSC		
Overall Height	А	-	-	1.20
Molded Package Thickness	A2	0.95	1.00	1.05
Standoff	A1	0.05	_	0.15
Foot Length	L	0.45	0.60	0.75
Footprint	L1	1.00 REF		
Foot Angle	ф	0°	3.5°	7°
Overall Width	Е	14.00 BSC		
Overall Length	D	14.00 BSC		
Molded Package Width	E1	12.00 BSC		
Molded Package Length	D1	12.00 BSC		
Lead Thickness	С	0.09	-	0.20
Lead Width	b	0.17	0.22	0.27
Mold Draft Angle Top	α	11°	12°	13°
Mold Draft Angle Bottom	β	11°	12°	13°

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Chamfers at corners are optional; size may vary.

3. Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.25 mm per side.

- 4. Dimensioning and tolerancing per ASME Y14.5M.
 - BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-092B

100-Lead Plastic Thin Quad Flatpack (PT) – 12x12x1 mm Body, 2.00 mm [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Chamfers at corners are optional; size may vary.
- 3. Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.25 mm per side.
- 4. Dimensioning and tolerancing per ASME Y14.5M.
 - BSC: Basic Dimension. Theoretically exact value shown without tolerances.
 - REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-100B

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

Microchip Trader Architecture — Flash Memory Fa Program Memory Product Group Pin Count — Tape and Reel Fla Temperature Ran Package — Pattern —	PIC 24 FJ 256 GB1 10 T - I / PT - XXX nark	 Examples: a) PIC24FJ64GB106-I/PT: PIC24F device with USB On-The-Go, 64-Kbyte program memory, 64-pin, Industrial temp.,TQFP package. b) PIC24FJ256GB110-I/PT: PIC24F device with USB On-The-Go, 256-Kbyte program memory, 100-pin, Industrial temp.,TQFP package. 		
Architecture	24 = 16-bit modified Harvard without DSP			
Flash Memory Family FJ = Flash program memory				
Product Group	oduct Group GB1 = General purpose microcontrollers with USB On-The-Go			
Pin Count	06 = 64-pin 08 = 80-pin 10 = 100-pin			
Temperature Range	e Range I = -40°C to +85°C (Industrial)			
Package	PF = 100-lead (14x14x1 mm) TQFP (Thin Quad Flatpack) PT = 64-lead, 80-lead, 100-lead (12x12x1 mm) TQFP (Thin Quad Flatpack) MR = 64-lead (9x9x0.9 mm) QFN (Quad Flatpack No Leads)			
Pattern Three-digit QTP, SQTP, Code or Special Requirements (blank otherwise) ES = Engineering Sample				